

## MOTIVATION

- We focus on reducing the offset in the measurement of a Low-G accelerometer MEMS sensor.
- The behavior of the offset changes with temperature and angle of orientation.
- The goal of this project is to devise a method to reduce offset over extreme temperature ranges.
- A Deep neural network (DNN) can predict the offset behavior with a set of test temperatures.
- This DNN predictor will significantly reduce the resources required during the test time.



## POTENTIAL APPLICATIONS

- Sensors with high precision and sensitivity are an essential part of :
  - a. Cyber physical systems
  - b. Wireless sensor networks
  - c. Health monitoring applications
  - d. Military applications

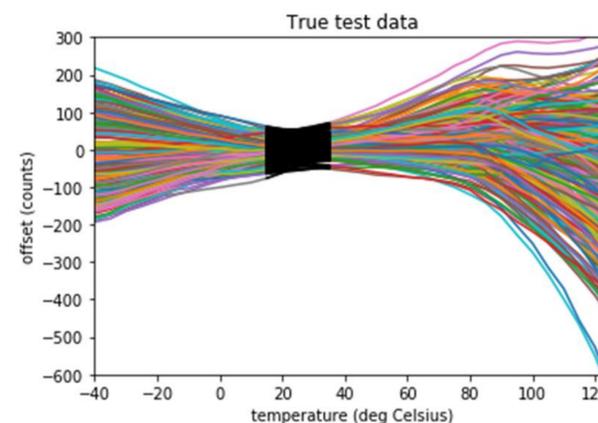
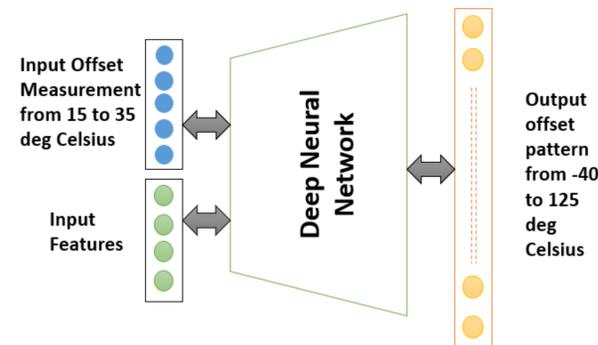
For high precision sensors, we need to reduce the offset.

## FACTORS RESPONSIBLE FOR OFFSET

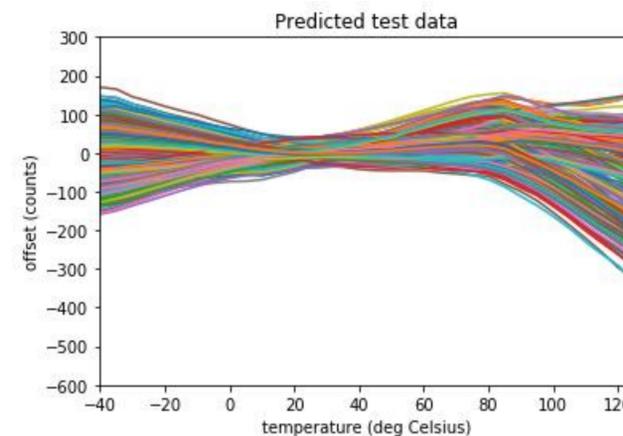
Factors that induce offset in the sensor measurements are

1. Temperature
2. Mechanical stress
3. Socket stress
4. Sensor reuse
5. Angle of orientation

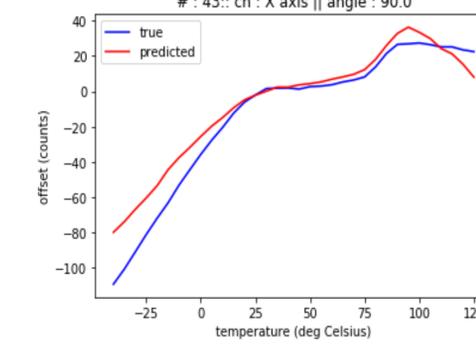
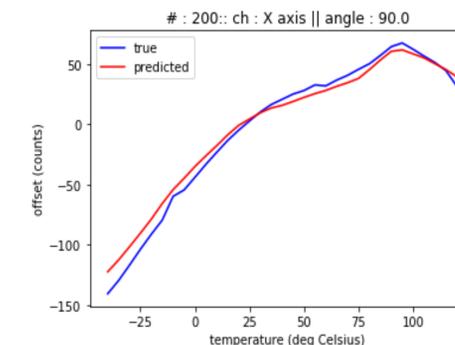
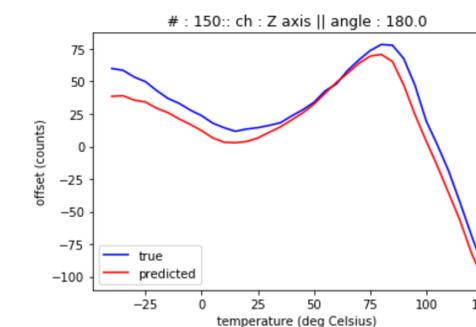
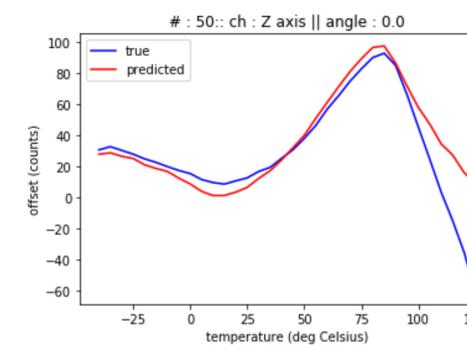
## DNN PREDICTOR



**DNN sees only the masked portion of input and extrapolates across temperature**



## SIMULATION RESULTS



## CONCLUSIONS

- A behavioral model for Offset is designed.
- A DNN predictor to predict offset pattern over temperature.
- A model will be devised to include the predictions of DNN and behavioral model to correct offset.
- DNN model significantly reduces resources during test time.

## ACKNOWLEDGEMENTS

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## REFERENCES

- [1] M. Stanley and Jong Ming Lee, "Sensors for IoT Applications", ISBN 9781627054638, editor Andreas Spanias, Synthesis Lectures, Morgan and Claypool Publishers, 113 Pages, March 2018.
- [2] J. Lee, M. Stanley, A. Spanias, C. Tepedelenioglu, "Integrating Machine Learning in Embedded Sensor Systems for Internet-of-Things Applications," Proc. 2016 IEEE International Symposium on Signal Processing and Information Systems (ISSPIT 2016), Dec. 2016.